

Statement of Compliance

Requested Part

08 June 2023 1-17754		69-3	(Part 1 of 1)
	TE Internal Number:	1-1775469-3	
Product Description:		HPI CONN., 2.0MM, R/A, SMT, 13P, 80U"	
	Part Status:	Active	
	Mil-Spec Certified:	No	
EU RoH	S Directive 2011/65/EU:	Compliant	
This declaration covers EU Directive 2011/65/EU incl. Delegated Directive 2015/863/EU.			
	EU ELV Directive: 2000/53/EC	Compliant	
	China RoHS 2 Directive: MIIT Order No 32, 2016	No Restricted Materials Above	Threshold
	EU REACH Regulation: (EC) No. 1907/2006	Current ECHA Candidate List: JAN Candidate List Declared Against: JA Does not contain REACH SVHC	. ,
	Halogen Content:	Not Low Halogen - contains Br or Cl	> 900 ppm.
Solder P	Process Capability Code:	Reflow solder capable to 260°C	
TE Connectivity Cornerat	ion		

TE Connectivity Corporation

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked.

Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV).

Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

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This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change.